

## ADP1050 Die Revision

| QUALIFICATION RESULTS  |                            |                  |                           |
|--|----------------------------|------------------|---------------------------|
| TEST   | SPECIFICATION              | SAMPLE SIZE      | RESULTS                   |
| Solder Heat Resistance (SHR)*  | JEDEC/IPC <i>J-STD-020</i> | <b>30</b>        | <b>Pass</b>               |
| Latch-Up   | JEDEC <i>JESD78</i>        | <b>9</b>         | <b>Pass ±200mA, +5.4V</b> |
| Electrostatic Discharge<br><i>Human Body Model</i>                   | ESDA/JEDEC <i>JS-001</i>   | <b>3/voltage</b> | <b>Pass ±5.5kV</b>        |
| Electrostatic Discharge<br><i>Field-Induced Charged Device Model</i> | JEDEC <i>JESD22-C101</i>   | <b>3/voltage</b> | <b>Pass ±1.25kV</b>       |

\*Preconditioned per JEDEC/IPC J-STD-020